Not Recommended for New Design
Please Use ZXRC250

PRECISION 2.5 VOLT MICROPOWER VOLTAGE REFERENCE

ISSUE 2 - FEBRUARY 1998

ZREF25

DEVICE DESCRIPTION

The ZREF25 uses a bandgap circuit design to achieve a precision micropower voltage reference of 2.5 volts. The device is available in a small outline surface mount package, ideal for applications where space saving is important as well as packages for through hole requirements.

The ZREF25 design provides a stable voltage without an external capacitor and is stable with capacitive loads. The ZREF25 is recommended for operation between 50µA and 5mA and so is ideally suited to low power and battery powered applications.

Excellent performance is maintained to an absolute maximum of 25mA, however the rugged design and 20 volt processing allows the reference to withstand transient effects and currents up to 200mA. Superior switching capability allows the device to reach stable operating conditions in only a few microseconds.

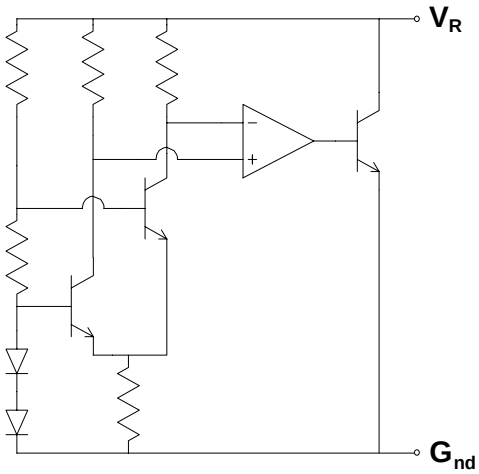
FEATURES

- Small outline SO8 and TO92 style packages.
- No stabilising capacitor required
- Typical T_C 30ppm/°C
- Typical slope resistance 0.4Ω
- 2% and 1% tolerance
- Industrial temperature range (Military temperature range available on request)
- Operating current 50µA to 5mA
- Transient response, stable in less than 10µs
- Alternative package options and tolerances are available

APPLICATIONS

- Battery powered and portable equipment.
- Metering and measurement systems.
- Instrumentation.
- Test equipment.
- Data acquisition systems.
- Precision power supplies.

SCHEMATIC DIAGRAM



Not Recommended for New Design
Please Use ZXRC250

ZREF25

ABSOLUTE MAXIMUM RATING

Reverse Current	25mA
Forward Current	25mA
Operating Temperature	-40 to 85°C
Storage Temperature	-55 to 125°C

Power Dissipation (T_{amb}=25°C)

E-Line, 3 pin (TO92)	500mW
E-Line, 2 pin (TO92)	500mW
SO8	625mW

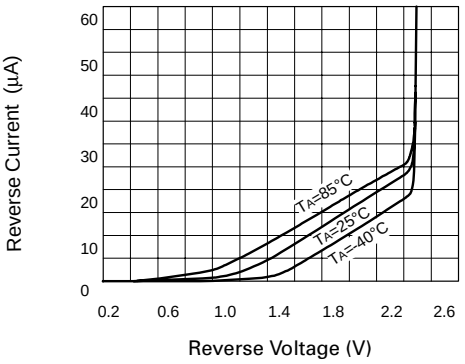
ELECTRICAL CHARACTERISTICS
TEST CONDITIONS (Unless otherwise stated) T_{amb}=25°C

SYMBOL	PARAMETER	CONDITIONS	LIMITS			TOL. %	UNITS
			MIN	TYP	MAX		
V_R	Reverse Breakdown Voltage	I_R=150µA	2.475 2.45	2.5 2.5	2.525 2.55	1 2	V
I_{MIN}	Minimum Operating Current			25	50		µA
I_R	Recommended Operating Current		0.05		5		mA
T_C †	Average Reverse Breakdown Voltage Temp. Co.	$I_{R(min)}$ to $I_{R(max)}$		30	90		ppm/°C
R_S §	Slope Resistance			0.4	2		Ω
Z_R	Reverse Dynamic Impedance	I_R = 1mA f = 100Hz I_{AC}=0.1 I_R		0.3	0.8		Ω
E_N	Wideband Noise Voltage	I_R= 150µA f = 10Hz to 10kHz		45			µV(rms)

† $$T_C = \frac{(V_{R(max)} - V_{R(min)}) \times 1000000}{V_R \times (T_{(max)} - T_{(min)})}$$

Note: $V_{R(max)}$ - $V_{R(min)}$ is the maximum deviation in reference voltage measured over the full operating temperature range.

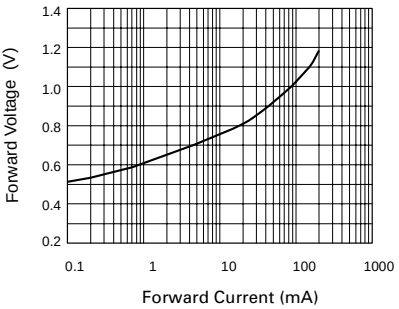
§ $$R_S = \frac{V_R \ Change (I_{R(min)} \ to \ I_{R(max)})}{I_{R(max)} - I_{R(min)}}$$



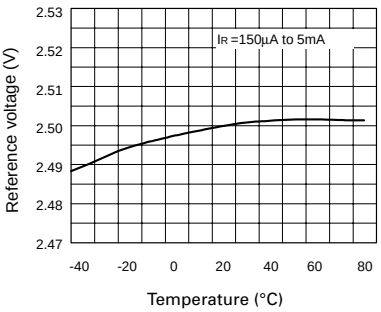
Reverse Characteristics

Not Recommended for New Design
Please Use ZXRC250

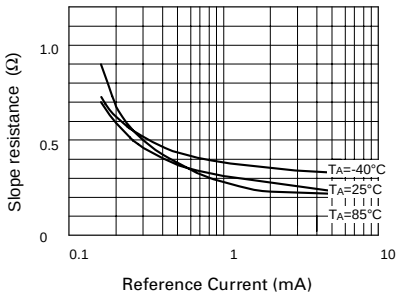
TYPICAL CHARACTERISTICS



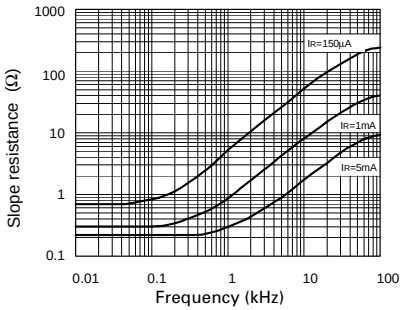
Forward Characteristics



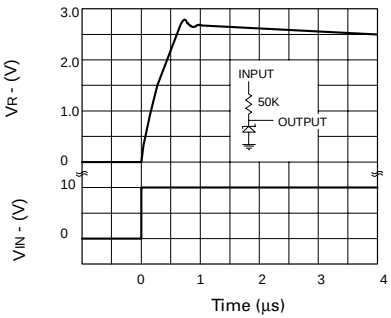
Temperature Drift



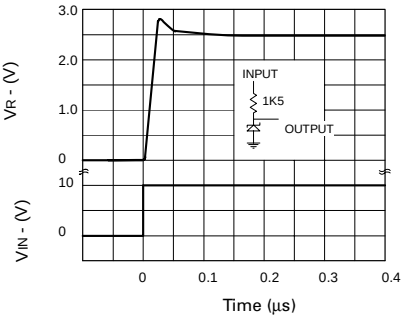
Slope Resistance v Current



Slope Resistance v Frequency



Transient Response (IR=150µA)



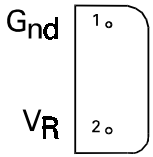
Transient Response (IR=5mA)

Not Recommended for New Design
Please Use ZXRC250

ZREF25

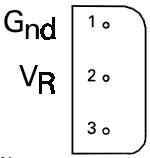
CONNECTION DIAGRAMS

E-Line, 2 pin Package Suffix – Y



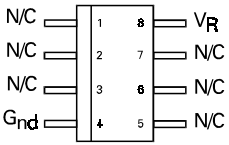
Bottom View

E-Line, 3 pin,Rev Package Suffix – R



Bottom View –
Pin 3 floating or connected to pin 1

SO8 Package Suffix – N8



Top View

ORDERING INFORMATION

Part No	Tol%	Package	Partmark
ZREF25D02	2	SO8	ZREF2502
ZREF25D	1	SO8	ZREF25
ZREF25Z02	2	E-Line *	ZREF2502
ZREF25Z	1	E-Line *	ZREF25
ZREF2502	2	E-Line †	ZREF2502
ZREF25	1	E-Line †	ZREF25

* E-Line 3 pin Reversed
† E-Line 2 pin